

MXD8651

SP5T Switch for Receive Diversity

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General Description

The MXD8651 is a low loss, high isolation SP5T switch with performance optimized for receive diversity routing applications.

The MXD8651 is compatible with +1.0V control logic, which is a key requirement for most cellular transceivers. This part is packaged in a compact 2mm x 2mm x 0.55 mm, 14-pin, QFN package which allows for a small solution size with no need for external DC blocking capacitors (when no external DC is applied to the device ports).

Features

- Excellent insertion loss and isolation performance
 - 0.5 dB Typical Insertion Loss, Band 7
 - 25 dB typical Isolation, Band 7
- Multi-Band operation 700MHz to 2700MHz
- GPIO compatible to 1.8V Typ (1.0V min)
- Power handling +30dBm
- Compact 2mm x 2mm x 0.55 mm, in QFN package, MSL1
- No DC blocking capacitors required (unless external DC is applied to the RF ports)

Applications

- Cellular Handset Applications
- Cellular modems and USB Devices
- Multi-mode GSM/Edge/WCDMA applications
- LTE applications

Functional Block Diagram and Pin Function

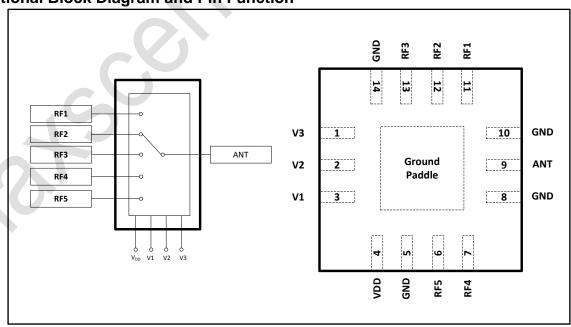


Figure 1. Functional Block Diagram and Pinout (Top View)



Application Circuit

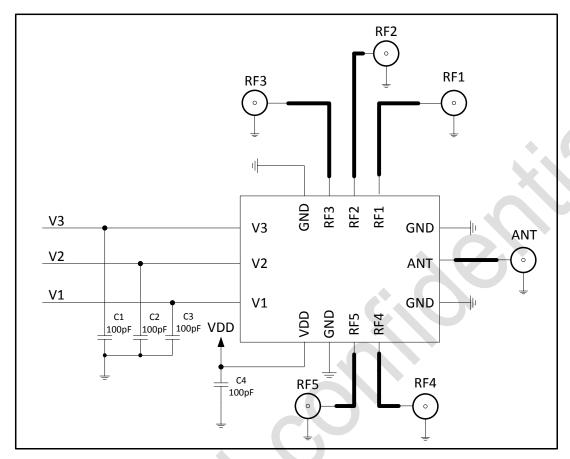


Figure 2. MXD8651 Evaluation Board Schematic

Table 1. Pin Description

| Pin No. | Nam | Description | Pin No. | Name | Description |
|---------------|----------|------------------|---------|------|-------------|
| | е | | | | |
| 1 | V3 | Control Logic #3 | 8 | GND | Ground |
| 2 | V2 | Control Logic #2 | 9 | ANT | Antenna |
| 3 | V1 | Control Logic #1 | 10 | GND | Ground |
| 4 | V_{DD} | Power supply | 11 | RF1 | RF port1 |
| 5 | GND | Ground | 12 | RF2 | RF port2 |
| 6 | RF5 | RF port5 | 13 | RF3 | RF port3 |
| 7 | RF4 | RF port4 | 14 | GND | Ground |
| Ground Paddle | GND | Ground | | | |

Note: Bottom ground paddles must be connected to ground.

Truth Table

Table 2.

| Control pins | | | Switched RF Outputs | | | | | | |
|--------------|----|----|---------------------|----------------|----------------|----------------|----------------|--|--|
| V1 | V2 | V3 | RF1 | RF2 | RF3 | RF4 | RF5 | | |
| 1 | 0 | 0 | Insertion Loss | Isolation | Isolation | Isolation | Isolation | | |
| 0 | 1 | 0 | Isolation | Insertion Loss | Isolation | Isolation | Isolation | | |
| 1 | 1 | 0 | Isolation | Isolation | Insertion Loss | Isolation | Isolation | | |
| 0 | 0 | 1 | Isolation | Isolation | Isolation | Insertion Loss | Isolation | | |
| 1 | 0 | 1 | Isolation | Isolation | Isolation | Isolation | Insertion Loss | | |

Note: "1" = 1.0 V to 3.0 V. "0" = 0 V to 0.3 V. Insertion loss in the V1/2/3 = 110 state is 3dB lower than typical insertion loss with only one arm "on".



Recommended Operation Range

Table 3. Recommended Operation Condition

| Parameters | Symbol | Min | Тур | Max | Units |
|-----------------------------|----------|-----|-----|-----|-------|
| Operation Frequency | f1 | 0.1 | • | 3.0 | GHz |
| Power supply | V_{DD} | 2.5 | 2.8 | 3.3 | V |
| Switch Control Voltage High | V_{H} | 1.0 | 1.8 | 3.0 | V |
| Switch Control Voltage Low | V_L | 0 | 0 | 0.3 | V |

Specifications

Table 4. Electrical Specifications

| Danamatan | Completed | Specification | | | 1124 | Test Condition | |
|-----------------------------------|--|----------------------------|--------------------------------------|------------|----------------------------|--|--|
| Parameter | Symbol | Min. | Typical | Max. | Units | (Note 2) | |
| DC Specifications | | | | | | | |
| Supply voltage | V_{DD} | 2.5 | 2.8 | 3.3 | ٧ | | |
| Supply current | I _{DD} | | 50 | 90 | μΑ | Active mode | |
| Control voltage: High Low | V _{CTL_H} V _{CTL_L} | 1.0 0 | | 3.0 0.3 | V V | V _{DD} must be > V _{CTL} at all times | |
| Control current | I _{CTL} | | | 5 | μΑ | | |
| Switching Speed, on RF to another | | | 2 | 5 | μs | 10% to 90% RF | |
| Turn-on time | t _{on} | | 5 | 10 | μs | Time from V _{DD} =0V to part ON and RF at 90% | |
| RF Specifications | | | | | | | |
| Insertion Loss | | | | | | | |
| Insertion Loss TRx - ANT | IL | | 0.40 0.40 0.50 0.50 0.55 | | dB dB dB dB dB | 704MHz to 787MHz 815MHz to 960MHz 1710MHz to 1980MHz 2110MHz to 2170MHz 2300MHz to 2690MHz | |
| Isolation | | | 0.55 | | ub ub | 2300141112 to 2030141112 | |
| Isolated TRx ports - | ISO | 45 45 35 30 25 | | | dB dB dB dB | 704MHz to 787MHz 815MHz to 960MHz 1710MHz to 1980MHz 2110MHz to 2170MHz 2300MHz to 2690MHz | |
| Harmonics (Pin =+16 dBr | n) | | | | | | |
| Low Band, 2fo | | | -110 | | dBc | Pin = +16dBm, 50ohms, fo=824MHz | |
| Low Band, 3fo | | | -105 | | dBc | Pin = +16dBm, 50ohms, fo=824MHz | |
| High Band, 2fo | 2fo 3fo | | -105 | | dBc | Pin = +16dBm, 50ohms, fo=1980MHz | |
| High Band, 3fo | | | -100 | | dBc | Pin = +16dBm, 50ohms, fo=1980MHz | |
| High Band, 2fo | | | -100 | | dBc | Pin = +16dBm, 50ohms, fo=2570MHz | |
| High Band, 3fo | | | -100 | | dBc | Pin = +16dBm, 50ohms, fo=2570MHz | |
| VSWR | | | 1.1 | 1.5 | | 704-2690MHz | |



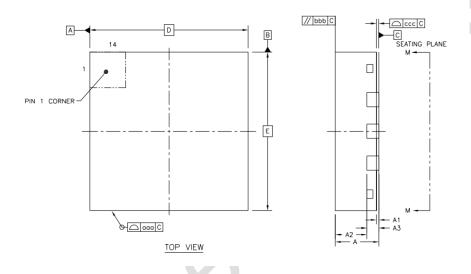
Absolute Maximum Ratings

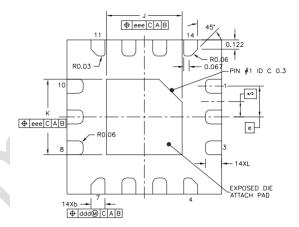
Table 5. Maximum ratings

| Parameters | Symbol | Minimum | Maximum | Units |
|---|------------------|---------|---------|--------------|
| Supply voltage | V_{DD} | 2.5 | +3.3 | V |
| Control voltage (V1, V2, and V3) | V _{CTL} | 0 | +3.0 | V |
| RF input power (RF1 to RF5) | P _{IN} | | +30 | dBm |
| Operating temperature | T _{OP} | -20 | +85 | $^{\circ}$ C |
| Storage temperature | T _{STG} | -40 | +125 | $^{\circ}$ C |
| Electrostatic Discharge, Human Body Model (HBM), Class 1C | ESD | | 1000 | v |

Note: Exposure to maximum rating conditions for extended periods may reduce device reliability. There is no damage to device with only one parameter set at the limit and all other parameters set at or below their nominal value. Exceeding any of the limits listed here may result in permanent damage to the device

Package Outline Dimension





| DECODIDEION | | SYMBOL | MILLIMETER | | | |
|--------------------|-----|--------|------------|------|------|--|
| DESCRIPTION | MIN | | NOM | MAX | | |
| TOTAL THICKNESS | | Α | 0.50 | 0.55 | 0.60 | |
| STAND OFF | | A1 | 0 | | 0.05 | |
| MOLD THICKNESS | | A2 | 0.35 | 0.40 | 0.45 | |
| L/F THICKNESS | | A3 | 0.152 REF | | | |
| LEAD WIDTH | | b | 0.13 | 0.18 | 0.23 | |
| BODY SIZE | X | D | 1.95 | 2.00 | 2.05 | |
| BODT SIZE | Υ | Ε | 1.95 | 2.00 | 2.05 | |
| LEAD PITCH | | е | 0.40 BSC | | | |
| EP SIZE | Х | J | 0.93 | 0.98 | 1.03 | |
| EP SIZE | Y | K | 0.93 | 0.98 | 1.03 | |
| LEAD LENGTH | L | 0.16 | 0.21 | 0.26 | | |
| PACKAGE EDGE TOLER | 000 | 0.100 | | | | |
| MOLD FLATNESS | bbb | 0.100 | | | | |
| COPLANARITY | ccc | 0.080 | | | | |
| LEAD OFFSET | ddd | 0.100 | | | | |
| EXPOSED PAD OFFSE | eee | 0.100 | | | | |

Figure 3. package outline dimension



Marking Specification

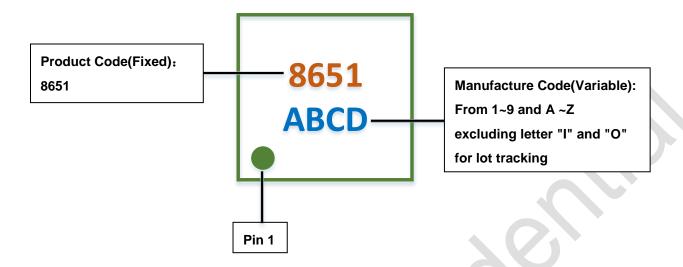


Figure 4. Marking specification (Top View)

Tape and Reel Dimensions

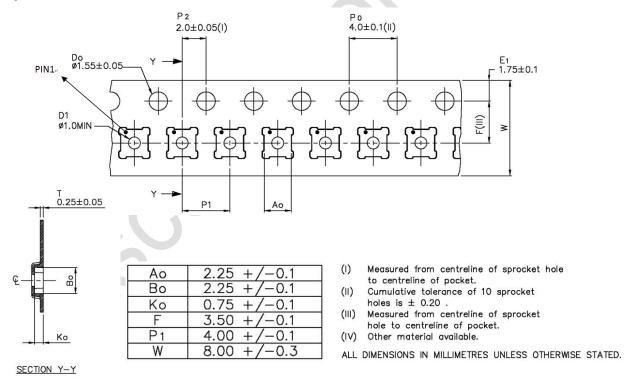


Figure 5. Tape and reel dimensions



Reflow Chart

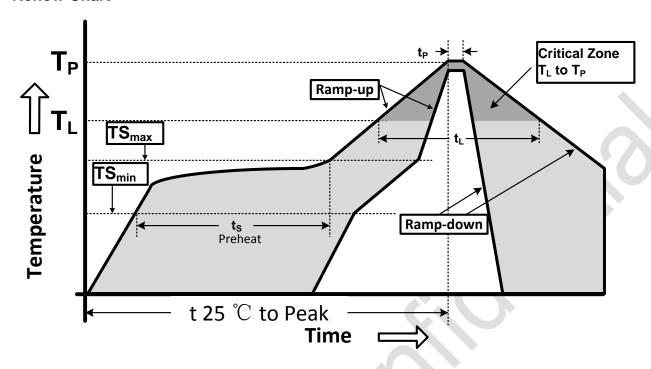


Figure 6. Recommended Lead-Free Reflow Profile

Table 6. Reflow condition

| Profile Parameter | Lead-Free Assembly, Convection, IR/Convection | | | |
|---|---|--|--|--|
| Ramp-up rate $(TS_{max} \text{ to } T_p)$ | 3℃/second max. | | | |
| Preheat temperature (TS _{min} to TS _{max}) | 150℃ to 200℃ | | | |
| Preheat time (t _s) | 60 - 180 seconds | | | |
| Time above TL , 217 $^{\circ}$ C (t_L) | 60 - 150 seconds | | | |
| Peak temperature (T _p) | 260℃ | | | |
| Time within 5°C of peak temperature(t _p) | 20 - 40 seconds | | | |
| Ramp-down rate | 6°C/second max. | | | |
| Time 25℃ to peak temperature | 8 minutes max. | | | |

ESD Sensitivity

Integrated circuits are ESD sensitive and can be damaged by static electric charge. Proper ESD protection techniques should be used when handling these devices.

RoHS Compliant

This product does not contain lead, mercury, cadmium, hexavalent chromium, polybrominated biphenyls (PBB) and polybrominated diphenyl ethers (PBDE), and are considered RoHS compliant.

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BGSX212MA18E6327XTSA1 SKY13446-374LF SW-227-PIN PE42524A-X CG2185X2 CG2415M6 MA4AGSW1A MA4AGSW2

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